



## DESCRIPTION

The MBR0530 uses the Schottky Barrier principle with a large area metal-to-silicon power diode. Ideally suited for low voltage, high frequency rectification or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. This package also provides an easy to work with alternative to leadless 34 package style. These state-of-the-art devices have the following features

The MBR0530 is available in SOD-123 Package

## ORDERING INFORMATION

Package Type	Part Number
SOD-123	MBR0530
Note	SPQ: 3,000pcs/Reel
AiT provides all RoHS Compliant Products	

## FEATURES

- Guardring for Stress Protection
- Low Forward Voltage
- 125°C Operating Junction Temperature
- Epoxy Meets UL 94, V-0 @ 0.125 in
- Package Designed for Optimal Automated Board Assembly
- Available in SOD-123 Package

## MECHANICAL CHARACTERISTICS

Polarity Designator: Cathode Band

Weight : 11.7mg(approximately)

Case: Epoxy, Molded

Finish: All External surfaces Corrosion resistant and Terminal Leads are readily Solderable.

Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds



## ABSOLUTE MAXIMUM RATINGS

V <sub>RRM</sub> , Peak Repetitive Reverse Voltage	30V
V <sub>RWM</sub> , Working Peak Reverse Voltage	30V
V <sub>R</sub> , DC Blocking Voltage	30V
I <sub>F(AV)</sub> , Average Rectified Forward Current (Rated V <sub>R</sub> , T <sub>L</sub> =100°C)	0.5A
I <sub>FSM</sub> , Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60Hz)	5.5A
T <sub>STG</sub> , Storage Temperature Range	-65°C~150°C
T <sub>J</sub> , Operating Junction Temperature	-65°C~125°C
dv/dt, Voltage Rate of Change (Rated V <sub>R</sub> )	1000 V/μs
ESD, Machine Model=C	> 400V
ESD, Human Body Model=3B	> 8000V

Stresses above may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the Electrical Characteristics are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance-Junction-to-Ambient <sup>NOTE1</sup>	R <sub>θJA</sub>	206	°C/W
Thermal Resistance-Junction-to-Lead	R <sub>θJL</sub>	150	°C/W

## ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Conditions	Value	Unit
Minimum Reverse Breakdown Voltage	V <sub>(BR)R</sub>	I <sub>R</sub> =130μA	30	V
Maximum Instantaneous Forward Voltage <sup>NOTE2</sup>	V <sub>F</sub>	I <sub>F</sub> =0.1Amps, T <sub>J</sub> =25°C	0.375	V
		I <sub>F</sub> =0.5Amps, T <sub>J</sub> =25°C	0.45	
Maximum Instantaneous Reverse Current <sup>NOTE2</sup>	I <sub>R</sub>	Rated DC Voltage, T <sub>C</sub> =25°C	130	μA
		V <sub>R</sub> =15 V, T <sub>C</sub> =25°C	20	

NOTE1: 1 inch square pad size (1 x 0.5 inch for each lead) on FR4 board.

NOTE2: Pulse Test: Pulse Width=300μs, Duty Cycle ≤ 2%.



## TYPICAL CHARACTERISTICS

Figure 1. Typical Forward Voltage

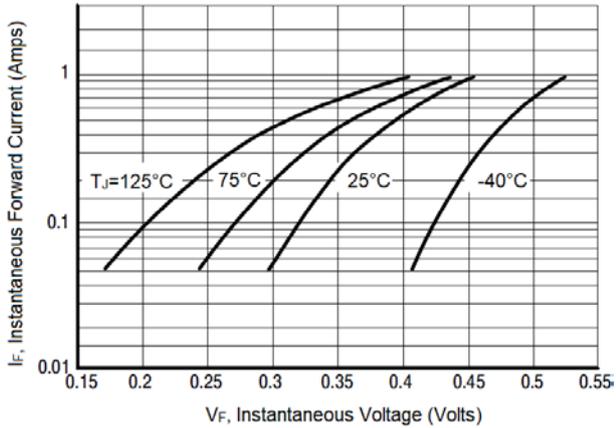


Figure 2. Typical Reverse Current

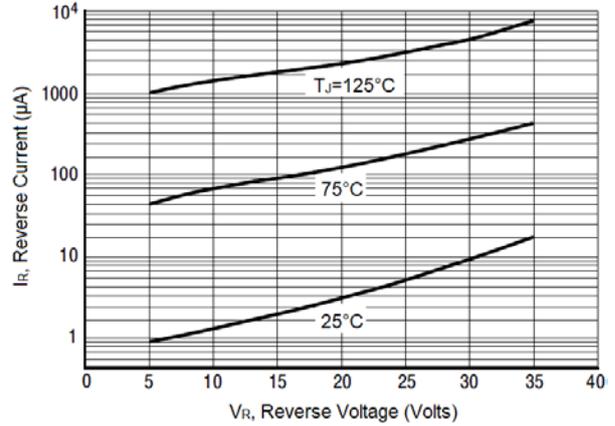


Figure 3. Typical Capacitance

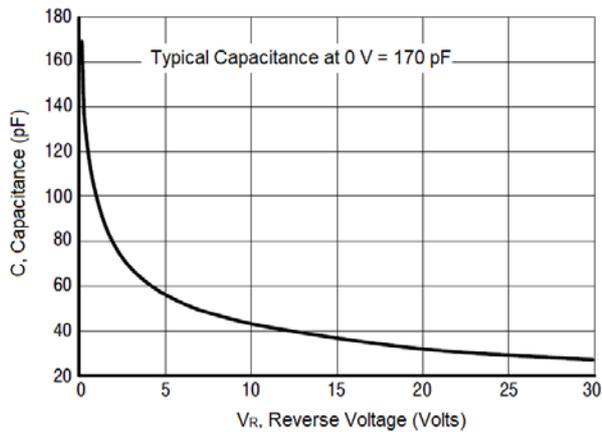


Figure 4. Current Derating (Lead)

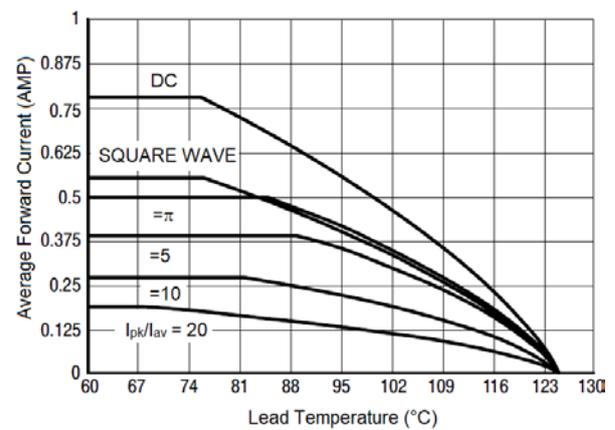
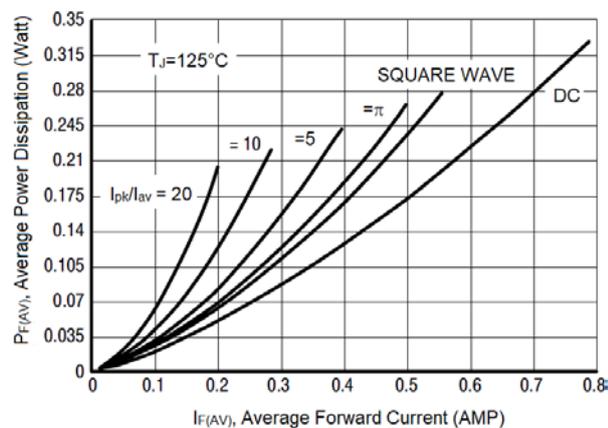


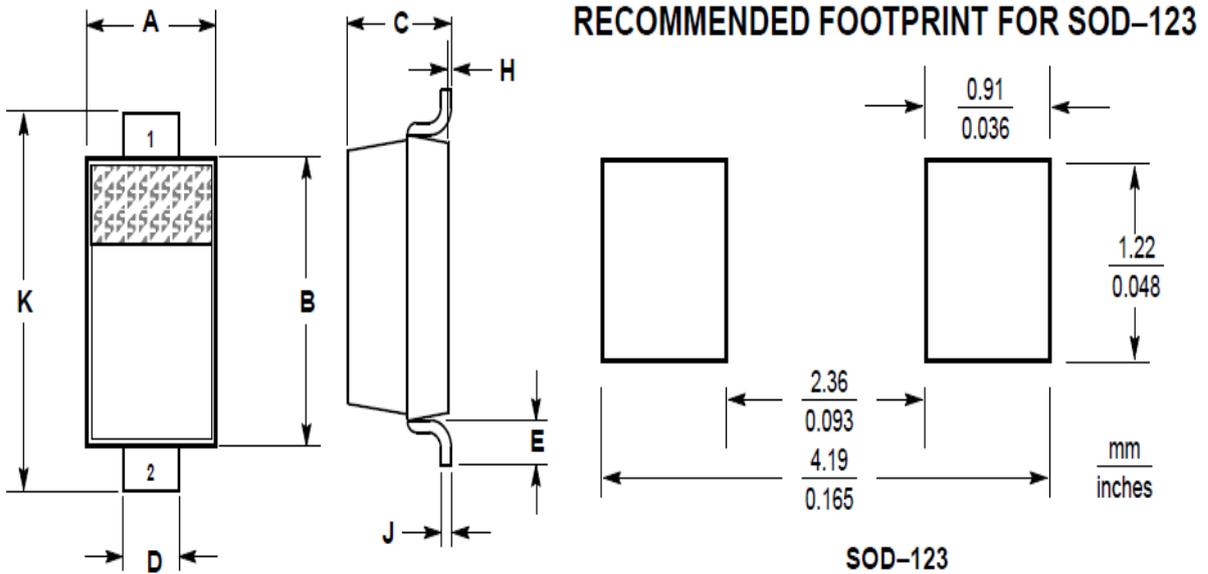
Figure 5. Power Dissipation





**PACKAGE INFORMATION**

Dimension in SOD-123 Package (Unit: mm)



Symbol	Millimeter		Inches	
	Min	Max	Min	Max
A	1.40	1.80	0.055	0.071
B	2.55	2.85	0.100	0.112
C	0.95	1.35	0.037	0.053
D	0.50	0.70	0.020	0.028
E	0.25	-	0.010	-
H	0.00	0.10	0.000	0.004
J	-	0.15	-	0.006
K	3.55	3.85	0.140	0.152



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